

C0603C152J2GACTU

Aliases (C0603C152J2GAC7867) SMD Comm C0G, Ceramic, 1,500 pF, 5%, 200 VDC, C0G, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 0603, 0.5 mm



Click here for the 3D model.

| General Information | |
|--------------------------|---|
| Series | SMD Comm COG |
| Style | SMD Chip |
| Description | SMD, MLCC, Ultra-Stable, Low Loss, Class I |
| Features | Ultra-Stable, Low Loss, Class I |
| RoHS | Yes |
| Termination | Tin |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 4.6 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| Specifications | |
|--|------------------------|
| Capacitance | 1,500 pF |
| Measurement Condition | 1 kHz 1.0Vrms |
| Tolerance | 5% |
| Voltage DC | 200 VDC |
| Dielectric Withstanding Voltage | 500 VDC |
| Temperature Range | -55/+125°C |
| Temp. Coefficient | COG |
| Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 30 ppm/C, 1kHz 1.0Vrms |
| Dissipation Factor | 0.1% 1 kHz 1.0Vrms |
| Aging Rate | 0% Loss/Decade Hour |
| Insulation Resistance | 100 GOhms |

 Dimensions

 Chip Size
 0603

 L
 1.6mm +/-0.15mm

 W
 0.8mm +/-0.15mm

 T
 0.85mm +/-0.07mm

 S
 0.5mm MIN

 B
 0.35mm +/-0.15mm

Packaging Specifications

| Packaging | T&R, 180mm, Paper Tape |
|--------------------|------------------------|
| Packaging Quantity | 4000 |
| | |

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